MC74AC05, MC74ACT05

Hex Inverter with Open-Drain Outputs

High−Performance Silicon−Gate CMOS

The MC74AC/ACT05 is identical in pinout to the LS05. The device inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with TTL outputs.

Features

- Outputs Source/Sink 24 mA
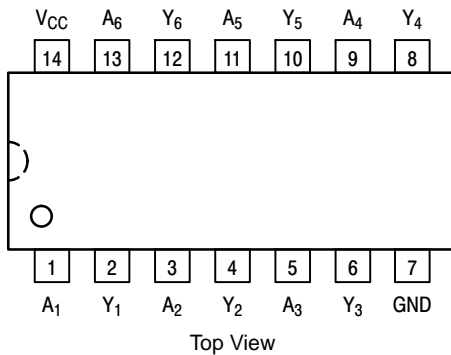- ′ACT05 Has TTL Compatible Inputs
- These are Pb−Free Devices

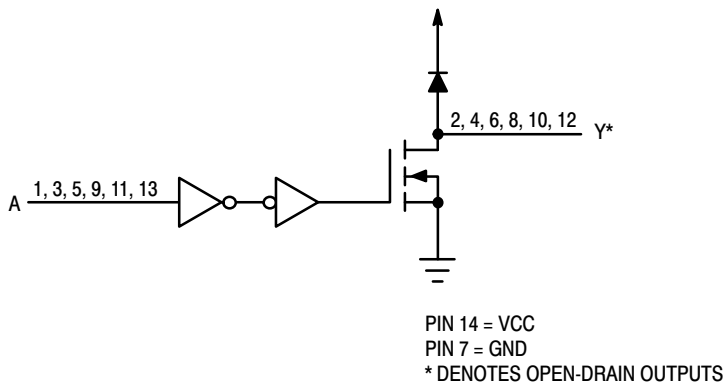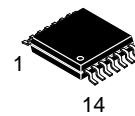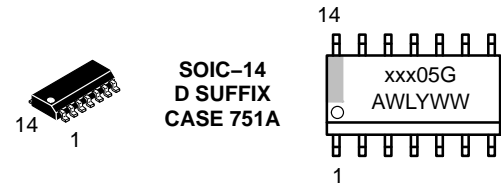**Figure 1. Pinout: 14-Lead Packages**

Top View

PIN 14 = VCC
PIN 7 = GND
* DENOTES OPEN-DRAIN OUTPUTS

Figure 2. Logic Diagram

ON Semiconductor®

MARKING DIAGRAMS

SOIC−14
D SUFFIX
CASE 751A

```
xxx05G
AWLYWW
```

TSSOP−14
DT SUFFIX
CASE 948G

```
xxx
05
ALYW■
```

xxx	= AC or ACT
A	= Assembly Location
WL or L	= Wafer Lot
Y	= Year
WW or W	= Work Week
G or ■	= Pb−Free Package

(Note: Microdot may be in either location)

FUNCTION TABLE

Input A	Output Y
L	Z
H	L

NOTE: Z = High Impedance

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

MAXIMUM RATINGS

Symbol	Parameter		Value	Unit
V_{CC}	DC Supply Voltage		-0.5 to $+7.0$	V
V_I	DC Input Voltage		$-0.5 \leq V_I \leq V_{CC} +0.5$	V
V_O	DC Output Voltage	(Note 1)	$-0.5 \leq V_O \leq V_{CC} +0.5$	V
I_{IK}	DC Input Diode Current		± 20	mA
I_{OK}	DC Output Diode Current		± 50	mA
I_O	DC Output Sink/Source Current		± 50	mA
I_{CC}	DC Supply Current per Output Pin		± 50	mA
I_{GND}	DC Ground Current per Output Pin		± 50	mA
T_{STG}	Storage Temperature Range		-65 to $+150$	°C
T_L	Lead temperature, 1 mm from Case for 10 Seconds		260	°C
T_J	Junction temperature under Bias		$+150$	°C
θ_{JA}	Thermal Resistance (Note 2)	SOIC TSSOP	125 170	°C/W
P_D	Power Dissipation in Still Air at 85°C	SOIC TSSOP	125 170	mW
MSL	Moisture Sensitivity		Level 1	
F_R	Flammability Rating Oxygen Index: 30% – 35%		UL 94 V–0 @ 0.125 in	
V_{ESD}	ESD Withstand Voltage Human Body Model (Note 3) Machine Model (Note 4) Charged Device Model (Note 5)		> 2000 > 200 > 1000	V
$I_{Latch-Up}$	Latch–Up Performance Above V_{CC} and Below GND at 85°C (Note 6)		± 100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
1. I_O absolute maximum rating must be observed.
2. The package thermal impedance is calculated in accordance with JESD51–7.
3. Tested to EIA/JESD22–A114–A.
4. Tested to EIA/JESD22–A115–A.
5. Tested to JESD22–C101–A.
6. Tested to EIA/JESD78.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Min	Typ	Min	Unit
V_{CC}	Supply Voltage	′AC	2.0	5.0	6.0	V
		′ACT	4.5	5.0	5.5	
VREG	DC Regulated Power Voltage (Ref. to GND)		0	–	V_{CC}	V
t_r, t_f	Input Rise and Fall Time (Note 1) ′AC Devices except Schmitt Inputs	V_{CC} @ 3.0 V	–	150	–	ns/V
		V_{CC} @ 4.5 V	–	40	–	
		V_{CC} @ 5.5 V	–	25	–	
t_r, t_f	Input Rise and Fall Time (Note 2) ′ACT Devices except Schmitt Inputs	V_{CC} @ 4.5 V	–	10	–	ns/V
		V_{CC} @ 5.5 V	–	8.0	–	
T_J	Junction Temperature (PDIP)		–	–	140	°C
T_A	Operating Ambient Temperature Range		–40	25	85	°C
I_{OH}	Output Current – HIGH		–	–	–24	mA
I_{OL}	Output Current – LOW		–	–	24	mA

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.
1. V_{in} from 30% to 70% V_{CC}; see individual Data Sheets for devices that differ from the typical input rise and fall times.
2. V_{in} from 0.8 V to 2.0 V; see individual Data Sheets for devices that differ from the typical input rise and fall times.

MC74AC05, MC74ACT05

DC CHARACTERISTICS

Symbol	Parameter	V_CC (V)	74AC T_A = +25°C Typ	74AC T_A = +25°C Guaranteed Limits	74AC T_A = −40°C to +85°C Guaranteed Limits	Unit	Conditions
V_{IH}	Minimum High Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	2.1 3.15 3.85	2.1 3.15 3.85	V	V_{OUT} = 0.1 V or V_{CC} − 0.1 V
V_{IL}	Maximum Low Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	0.9 1.35 1.65	0.9 1.35 1.65	V	V_{OUT} = 0.1 V or V_{CC} − 0.1 V
V_{OL}	Maximum Low Level Output Voltage	3.0 4.5 5.5	0.002 0.001 0.001	0.1 0.1 0.1	0.1 0.1 0.1	V	I_{OUT} = 50 μA
		3.0 4.5 5.5	− − −	0.36 0.36 0.36	0.44 0.44 0.44	V	*V_{IN} = V_{IL} or V_{IH} I_{OL} 12 mA 24 mA 24 mA
I_{IN}	Maximum Input Leakage Current	5.5	−	±0.1	±1.0	μA	V_I = V_{CC}, GND
I_{OLD}	†Minimum Dynamic Output Current	5.5	−	−	75	mA	V_{OLD} = 1.65 V Max
I_{OHD}		5.5	−	−	−75	mA	V_{OHD} = 3.85 V Min
I_{CC}	Maximum Quiescent Supply Current	5.5	−	4.0	40	μA	V_{IN} = V_{CC} or GND

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
*All outputs loaded; thresholds on input associated with output under test.
†Maximum test duration 2.0 ms, one output loaded at a time.

NOTE: I_{IN} and I_{CC} @ 3.0 V are guaranteed to be less than or equal to the respective limit @ 5.5 V.

AC CHARACTERISTICS

Symbol	Parameter	V_CC* (V)	74AC T_A = +25°C C_L = 50 pF Min	74AC T_A = +25°C C_L = 50 pF Typ	74AC T_A = +25°C C_L = 50 pF Max	74AC T_A = −40°C to +85°C C_L = 50 pF Min	74AC T_A = −40°C to +85°C C_L = 50 pF Max	Unit
t_{PZL}	Propagation Delay Output Enable	3.3 5.0	1.5 1.5	− −	8.0 6.0	1.0 1.0	9.0 6.5	ns
t_{PLZ}	Propagation Delay Output Enable	3.3 5.0	1.5 1.5	− −	8.0 6.0	1.0 1.0	9.0 6.5	ns

*Voltage Range 3.3 V is 3.3 V ±0.3 V.
  Voltage Range 5.0 V is 5.0 V ±0.5 V.

DC CHARACTERISTICS

Symbol	Parameter	V$_{CC}$ (V)	74ACT T$_A$ = +25°C		74ACT T$_A$ = −40°C to +85°C	Unit	Conditions
			Typ	Guaranteed Limits			
V$_{IH}$	Minimum High Level Input Voltage	4.5 5.5	1.5 1.5	2.0 2.0	2.0 2.0	V	V$_{OUT}$ = 0.1 V or V$_{CC}$ − 0.1 V
V$_{IL}$	Maximum Low Level Input Voltage	4.5 5.5	1.5 1.5	0.8 0.8	0.8 0.8	V	V$_{OUT}$ = 0.1 V or V$_{CC}$ − 0.1 V
V$_{OL}$	Maximum Low Level Output Voltage	4.5 5.5	0.001 0.001	0.1 0.1	0.1 0.1	V	I$_{OUT}$ = 50 μA
		4.5 5.5	− −	0.36 0.36	0.44 0.44	0.44	*V$_{IN}$ = V$_{IL}$ or V$_{IH}$ I$_{OH}$ 24 mA
I$_{IN}$	Maximum Input Leakage Current	5.5	−	±0.1	±1.0	μA	V$_I$ = V$_{CC}$, GND
ΔI$_{CCT}$	Additional Max. I$_{CC}$/Input	5.5	0.6	−	1.5	mA	V$_I$ = V$_{CC}$ − 2.1 V
I$_{OLD}$ I$_{OHD}$	†Minimum Dynamic Output Current	5.5 5.5	− −	− −	75 −75	mA mA	V$_{OLD}$ = 1.65 V Max V$_{OHD}$ = 3.85 V Min
I$_{CC}$	Maximum Quiescent Supply Current	5.5	−	4.0	40	μA	V$_{IN}$ = V$_{CC}$ or GND

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
*All outputs loaded; thresholds on input associated with output under test.
†Maximum test duration 2.0 ms, one output loaded at a time.

AC CHARACTERISTICS

Symbol	Parameter	V$_{CC}$* (V)	74ACT T$_A$ = +25°C C$_L$ = 50 pF			74ACT T$_A$ = −40°C to +85°C C$_L$ = 50 pF		Unit
			Min	Typ	Max	Min	Max	
t$_{PZL}$	Propagation Delay Output Enable	5.0	1.5	−	8.0	1.0	8.5	ns
t$_{PLZ}$	Propagation Delay Output Enable	5.0	1.5	−	8.5	1.0	9.0	ns

*Voltage Range 5.0 V is 5.0 V ±0.5 V.

CAPACITANCE

Symbol	Parameter	Value Typ	Unit	Test Conditions
C$_{IN}$	Input Capacitance	4.5	pF	V$_{CC}$ = 5.0 V
C$_{PD}$	Power Dissipation Capacitance	30	pF	V$_{CC}$ = 5.0 V

ORDERING INFORMATION

Device	Package	Shipping†
MC74AC05DG	SOIC−14 (Pb−Free)	55 Units / Rail
MC74AC05DR2G	SOIC−14 (Pb−Free)	2500 / Tape & Reel
MC74ACT05DG	SOIC−14 (Pb−Free)	55 Units / Rail
MC74ACT05DR2G	SOIC−14 (Pb−Free)	2500 / Tape & Reel
MC74ACT05DTR2G	TSSOP−14 (Pb−Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MC74AC05, MC74ACT05

PACKAGE DIMENSIONS

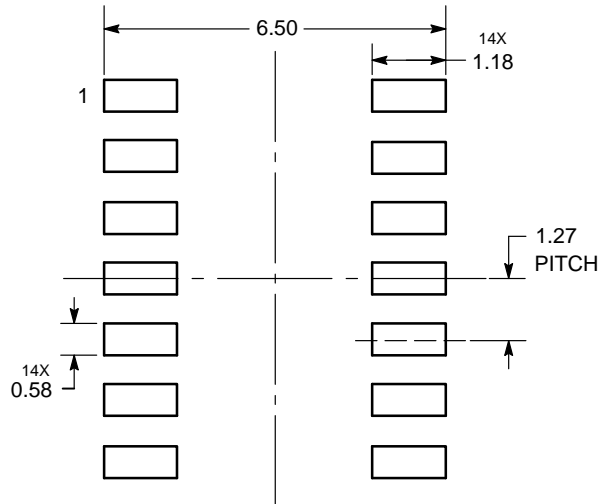**SOIC−14 NB**
CASE 751A−03
ISSUE K
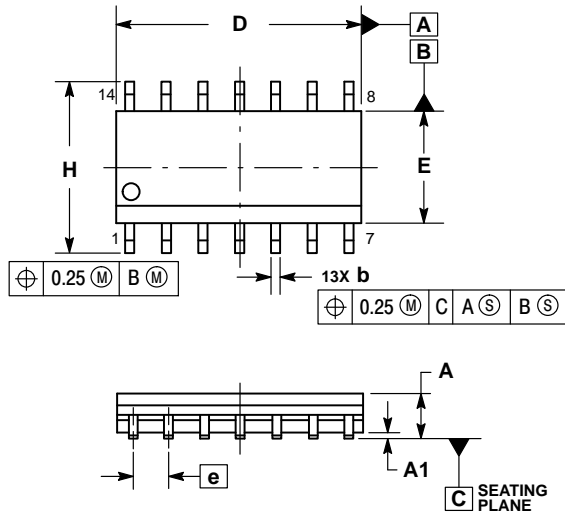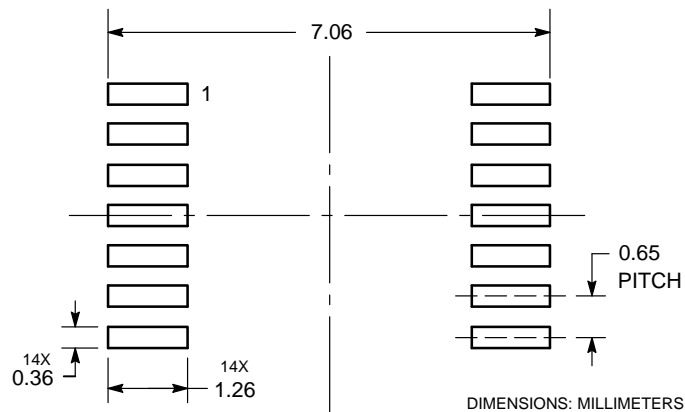
NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF AT MAXIMUM MATERIAL CONDITION.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSIONS.
5. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.35	1.75	0.054	0.068
A1	0.10	0.25	0.004	0.010
A3	0.19	0.25	0.008	0.010
b	0.35	0.49	0.014	0.019
D	8.55	8.75	0.337	0.344
E	3.80	4.00	0.150	0.157
e	1.27 BSC		0.050 BSC	
H	5.80	6.20	0.228	0.244
h	0.25	0.50	0.010	0.019
L	0.40	1.25	0.016	0.049
M	0 °	7 °	0 °	7 °

DETAIL A

SEATING PLANE

SOLDERING FOOTPRINT*

6.50

14X 1.18

1.27 PITCH

14X 0.58

DIMENSIONS: MILLIMETERS

*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PACKAGE DIMENSIONS

TSSOP–14
CASE 948G
ISSUE B
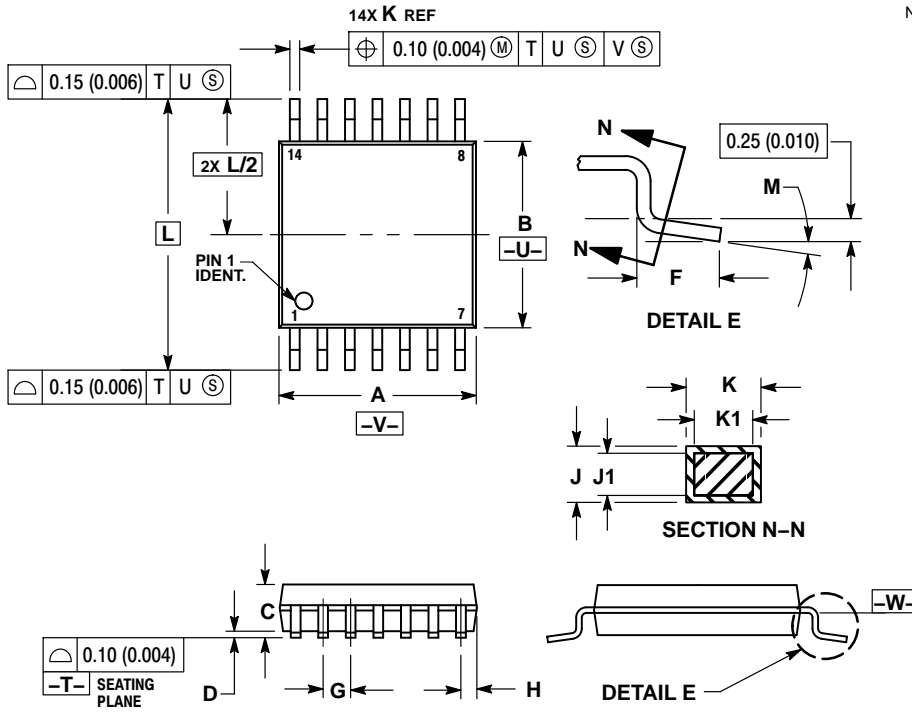
NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE –W–.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.90	5.10	0.193	0.200
B	4.30	4.50	0.169	0.177
C	–––	1.20	–––	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.50	0.60	0.020	0.024
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0 °	8 °	0 °	8 °

SOLDERING FOOTPRINT*

DIMENSIONS: MILLIMETERS

7.06

14X 0.36

14X 1.26

0.65 PITCH

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
Literature Distribution Center for ON Semiconductor
P.O. Box 5163, Denver, Colorado 80217 USA
Phone: 303–675–2175 or 800–344–3860 Toll Free USA/Canada
Fax: 303–675–2176 or 800–344–3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800–282–9855 Toll Free USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81–3–5817–1050

ON Semiconductor Website: **www.onsemi.com**

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

MC74AC05/D

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[ON Semiconductor]():
MC74AC05DG MC74AC05DR2G MC74ACT05DG MC74ACT05DR2G MC74ACT05DTR2G